

Power manegement (dual transistors)

Datasheet

<For Tr1>

| Parameter | Value |
|------------------|--------|
| V _{CEO} | -50V |
| Ι _C | -150mA |

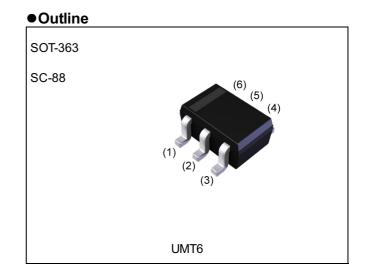
<For DTr2>

| Parameter | Value | |
|----------------------|-------|--|
| V _{CC} | 50V | |
| I _{C(Max.)} | 100mA | |

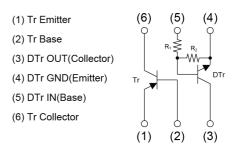
Features

1)Power switching circuit (2SA1576A/DTC124XUA) in a single package.

2)Mounting cost and area can be cut in half.



Inner circuit



Application

Power manegement

Packaging specifications

| Part No. | Package | Package size | Taping code | Reel size (mm) | Tape width (mm) | Basic ordering unit.(pcs) | Marking |
|----------|-------------------|-----------------|----------------|-------------------|--------------------|---------------------------------|---------|
| UMF28N | SOT-363 (UMT6) | 2021 | TR | 180 | 8 | 3000 | F28 |

• Absolute maximum ratings ($T_a = 25^{\circ}C$)

<Tr1>

| Parameter | Symbol | Limits | Unit |
|---------------------------|------------------|--------|------|
| Collector-base voltage | V _{CBO} | -60 | V |
| Collector-emitter voltage | V _{CEO} | -50 | V |
| Emitter-base voltage | V _{EBO} | -6 | V |
| Collector current | ۱ _C | -150 | mA |

<DTr2>

| Parameter | Symbol | Limits | Unit |
|-------------------|------------------------|-----------|------|
| Supply voltage | V _{CC} | 50 | V |
| Input voltage | V _{IN} | -10 to 40 | V |
| Output current | I _O | 50 | mA |
| Collector current | I _{C(MAX)} *2 | 100 | mA |

<Tr1> <DTr2>

| Parameter | Symbol | Limits | Unit |
|------------------------------|--------------------------------|------------|------|
| Power dissipation | P _D ^{*1*3} | 150 | mW |
| Junction temperature | Тj | 150 | °C |
| Range of storage temperature | T _{stg} | -55 to 150 | °C |



| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit |
|--------------------------------------|----------------------|---|------|------|------|------|
| Collector-base breakdown voltage | BV _{CBO} | Ι _C = -50μΑ | -60 | - | - | V |
| Collector-emitter breakdown voltage | BV _{CEO} | I _C = -1mA | -50 | - | - | V |
| Emitter-base breakdown voltage | BV_{EBO} | Ι _Ε = -50μΑ | -6 | - | - | V |
| Collector cut-off current | I _{CBO} | V _{CB} = -60V | - | - | -100 | nA |
| Emitter cut-off current | I _{EBO} | V _{EB} = -6V | - | - | -100 | nA |
| Collector-emitter saturation voltage | V _{CE(sat)} | l _C = -50mA, l _B = -5mA | - | - | -500 | mV |
| DC current gain | h _{FE} | V _{CE} = -6V, I _C = -1mA | 180 | - | 390 | - |
| Transition frequency | f _T | V _{CE} = -12V, I _E = 2mA, f = 100MHz | - | 140 | - | MHz |
| Output capacitance | C _{ob} | V _{CB} = -12V, I _E = 0mA, f = 1MHz | - | 4.0 | 5.0 | pF |

● Electrical characteristics (T_a = 25°C) <For Tr1>

•Electrical characteristics (Ta = 25°C) <For DTr2>

| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit |
|----------------------|---------------------|---|------|------|------|------|
| | V _{I(off)} | V _{CC} = 5V, I _O = 100µA | - | - | 0.4 | V |
| Input voltage | V _{I(on)} | V _O = 0.3V, I _O = 2mA | 2.5 | - | - | V |
| Output voltage | V _{O(on)} | I _O / I _I = 10mA / 0.5mA | - | 100 | 300 | mV |
| Input current | I _I | V _I = 5V | - | - | 360 | μA |
| Output current | I _{O(off)} | V _{CC} = 50V, VI = 0V | - | - | 500 | nA |
| DC current gain | G _I | V _O = 5V, I _O = 5mA | 68 | - | - | - |
| Input resistance | R ₁ | - | 15.4 | 22 | 28.6 | kΩ |
| Resistance ratio | R_2/R_1 | - | 1.7 | 2.1 | 2.6 | - |
| Transition frequency | f_{T}^{*2} | V _{CE} = 10V, I _E = -5mA, f = 100MHz | | 250 | - | MHz |

*1 Each termunal mounted on a reference land.

- *2 Characteristics of built-in transistor.
- *3 120mW per element must not be exceeded.

ROHM

UMF28N

Electrical characteristic curves(T_a=25°C) <For Tr1>

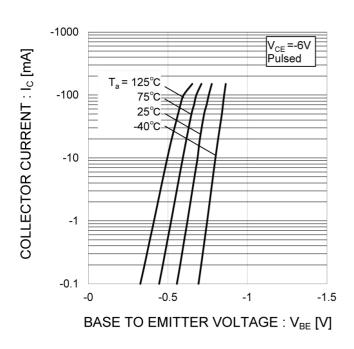


Fig.1 Grounded emitter propagation characteristics

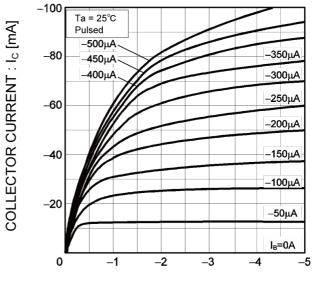
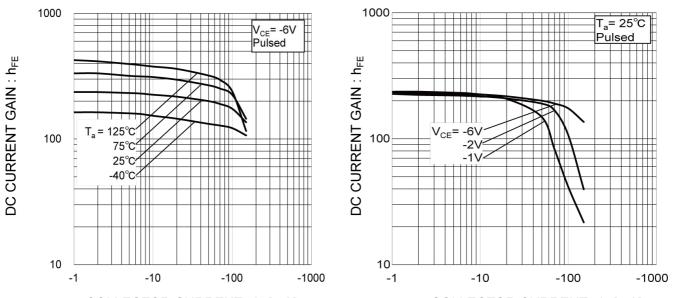


Fig.2 Grounded emitter output characteristics

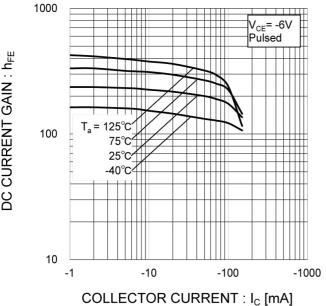
COLLECTOR TO EMITTER VOLTAGE : V_{CE} [V]

Fig.4 DC current gain vs. collector current (II)



COLLECTOR CURRENT : Ic [mA]

Fig.3 DC current gain vs. collector current (I)





•Electrical characteristic curves(Ta=25°C) <For Tr1>

Fig.5 Collector- emitter saturation voltage

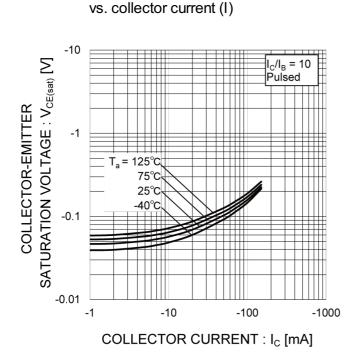


Fig.6 Collector- emitter saturation voltage vs. collector current (II)

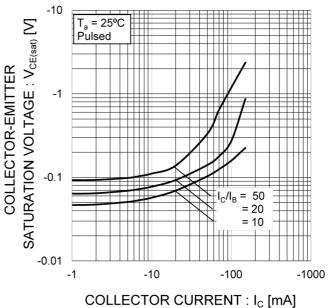


Fig.7 Base- emitter saturation voltage vs. collector current

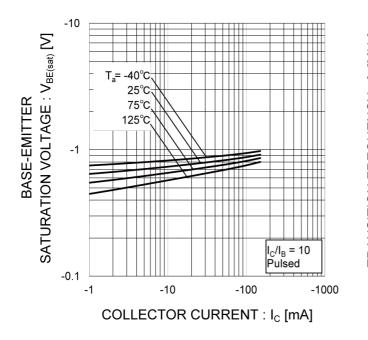
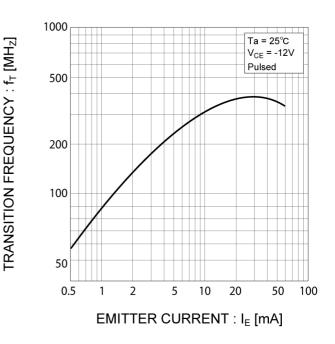


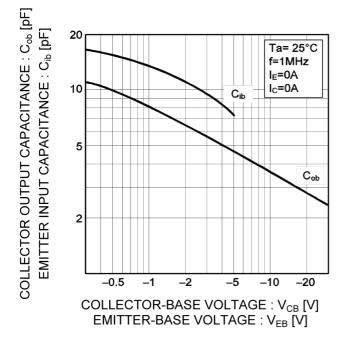
Fig.8 Gain bandwidth product vs. emitter current





Electrical characteristic curves(T_a=25°C) <For Tr1>

Fig.9 Emitter Input Capacitance vs. Emitter-Base Voltage Collector Output Capacitance vs. Collector-Base Voltage





Electrical characteristic curves(T_a=25°C) <For DTr2>

Fig.1 Input Voltage vs. Output Current

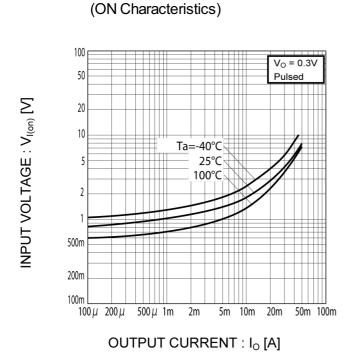


Fig.2 Output Current vs. Input Voltage (OFF Characteristics)

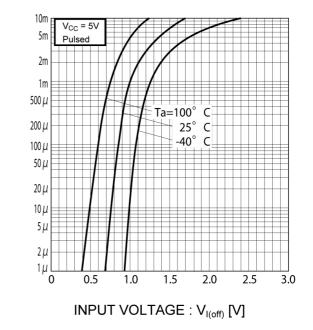


Fig.3 Output Current vs. Output Voltage

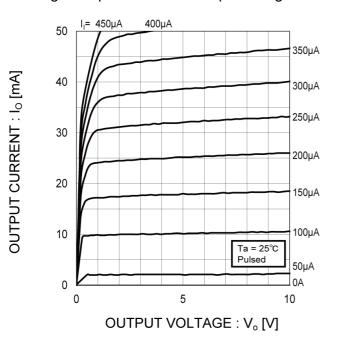
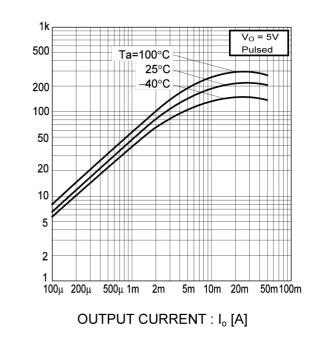


Fig.4 DC Current Gain vs. Output Current





DC CURRENT GAIN : G

OUTPUT CURRENT : I_o [A]

•Electrical characteristic curves(Ta=25°C) <For DTr2>

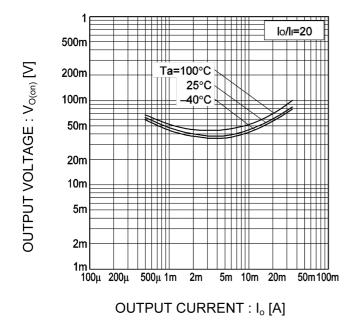
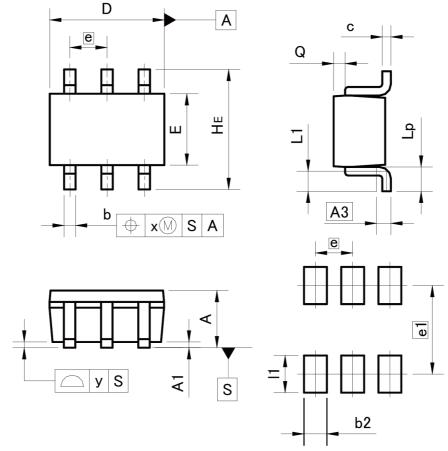


Fig.5 Output Voltage vs. Output Current



Dimensions

UMT6



Pattern of terminal position areas [Not a recommended pattern of soldering pads]

| DIM | MILIM | ETERS | INC | HES |
|-----|-------|-------|-------|-------|
| DIN | MIN | MAX | MIN | MAX |
| А | 0.80 | 1.00 | 0.031 | 0.039 |
| A1 | 0.00 | 0.10 | 0.000 | 0.004 |
| A3 | 0. | 25 | 0.0 | 10 |
| b | 0.15 | 0.30 | 0.006 | 0.012 |
| С | 0.10 | 0.20 | 0.004 | 0.008 |
| D | 1.90 | 2.10 | 0.075 | 0.083 |
| E | 1.15 | 1.35 | 0.045 | 0.053 |
| е | 0. | 65 | 0.0 | 26 |
| HE | 2.00 | 2.20 | 0.079 | 0.087 |
| L1 | 0.20 | 0.50 | 0.008 | 0.020 |
| Lp | 0.25 | 0.55 | 0.010 | 0.022 |
| Q | 0.10 | 0.30 | 0.004 | 0.012 |
| х | _ | 0.10 | - | 0.004 |
| У | _ | 0.10 | - | 0.004 |

| DIM | MILIM | ETERS | INCHES | | |
|-----|-------|-------|---------|-------|--|
| DIM | MIN | MAX | MIN | MAX | |
| b2 | - | 0.40 | - 0.016 | | |
| e1 | 1. | 55 | 0.0 | 61 | |
| 1 | - | 0.65 | - | 0.026 | |

Dimension in mm/inches



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 - [d] the Products are exposed to high Electrostatic
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